Description

This 25-bit 1:1 or 14-bit 1:2 configurable registered buffer is designed for 1.7-V to 1.9-V V_{DD} operation.

All clock and data inputs are compatible with the JEDEC standard for SSTL_18. The control inputs are LVCMOS. All outputs are 1.8-V CMOS drivers that have been optimized to drive the DDR-II DIMM load. ICSSSTUAF32866C operates from a differential clock (CLK and $\overline{CLK}$). Data are registered at the crossing of CLK going high, and $\overline{CLK}$ going low.

The C0 input controls the pinout configuration of the 1:2 pinout from A configuration (when low) to B configuration (when high). The C1 input controls the pinout configuration from 25-bit 1:1 (when low) to 14-bit 1:2 (when high).

A - Pair Configuration (C01 = 0, C11 = 1 and C02 = 0, C12 = 1)

Parity that arrives one cycle after the data input to which it applies is checked on the PAR_IN of the first register. The second register produces to PPO and $\overline{QERR}$ signals. The $\overline{QERR}$ of the first register is left floating. The valid error information is latched on the $\overline{QERR}$ output of the second register. If an error occurs $\overline{QERR}$ is latched low for two cycles or until $\overline{RESET}$ is low.

B - Single Configuration (C0 = 0, C1 = 0)

The device supports low-power standby operation. When the $\overline{RESET}$ input ($\overline{RESET}$) is low, the differential input receivers are disabled, and undriven (floating) data, clock and reference voltage (V_{REF}) inputs are allowed. In addition, when $\overline{RESET}$ is low all registers are reset, and all outputs are forced low. The LVCMOS $\overline{RESET}$ and Cn inputs must always be held at a valid logic high or low level. To ensure defined outputs from the register before a stable clock has been supplied, $\overline{RESET}$ must be held in the low state during power up.

In the DDR-II RDIMM application, $\overline{RESET}$ is specified to be completely asynchronous with respect to CLK and $\overline{CLK}$. Therefore, no timing relationship can be guaranteed between the two. When entering reset, the register will be cleared and the outputs will be driven low quickly, relative to the time to disable the differential input receivers. However, when coming out of reset, the register will become active quickly, relative to the time to enable the differential input receivers. As long as the data inputs are low, and the clock is stable during the time from the low-to-high transition of $\overline{RESET}$ until the input receivers are fully enabled, the design of the ICSSSTUAF32866C must ensure that the outputs will remain low, thus ensuring no glitches on the output.

The device monitors both $\overline{DCS}$ and $\overline{CSR}$ inputs and will gate the Qn outputs from changing states when both $\overline{DCS}$ and $\overline{CSR}$ inputs are high. If either $\overline{DCS}$ and $\overline{CSR}$ input is low, the Qn outputs will function normally. The $\overline{RESET}$ input has priority over the $\overline{DCS}$ and $\overline{CSR}$ control and will force the outputs low. If the $\overline{DCS}$-control functionality is not desired, then the $\overline{CSR}$ input can be hardwired to ground, in which case, the setup-time requirement for $\overline{DCS}$ would be the same as for the other D data inputs. Package options include 96-ball LFBGA (MO-205CC).

Features

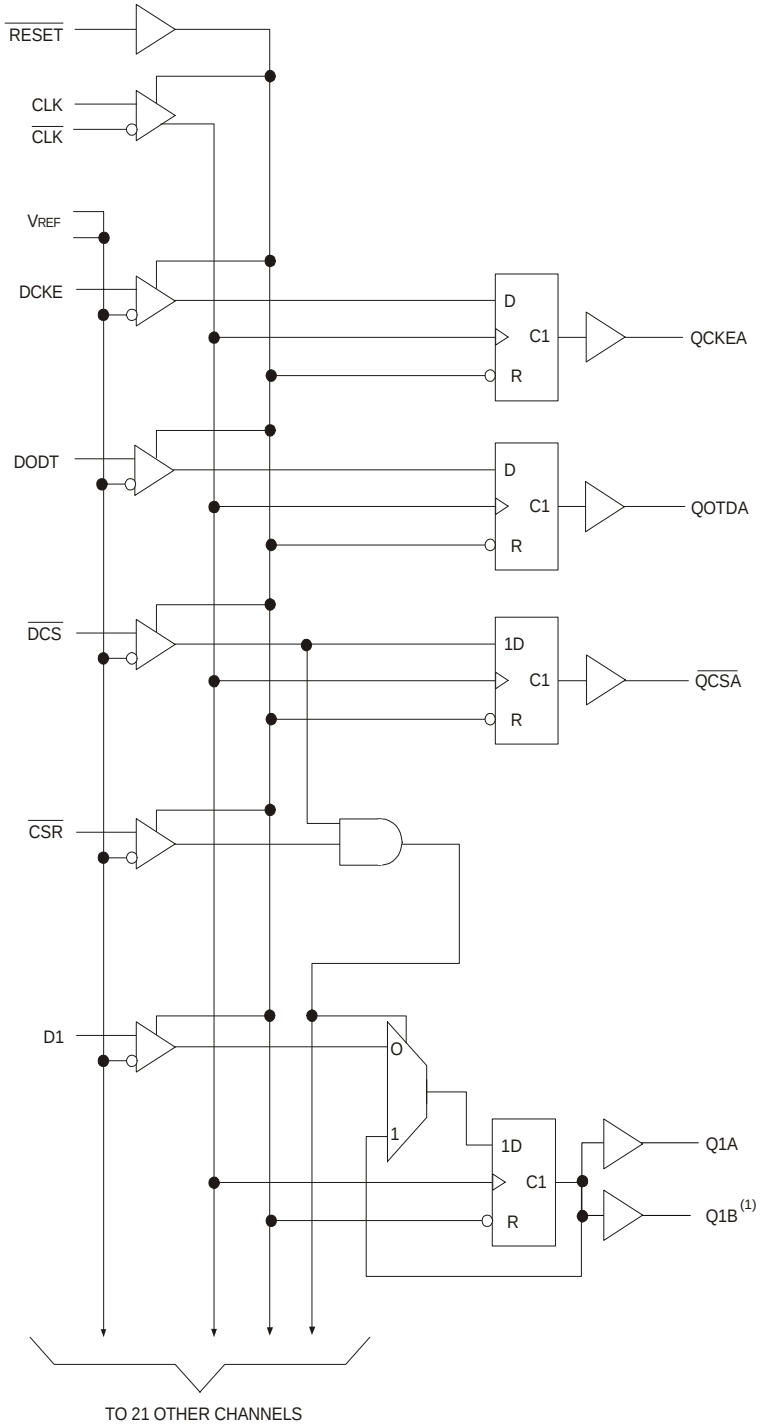
- 25-bit 1:1 or 14-bit 1:2 registered buffer with parity check functionality
- Supports SSTL_18 JEDEC specification on data inputs and outputs
- Supports LVCMOS switching levels on C0, C1, and $\overline{RESET}$ inputs
- Low voltage operation: V_{DD} = 1.7V to 1.9V
- Drop-in replacement for ICSSSTUA32864
- Available in 96-ball BGA package

Applications

- DDR2 Memory Modules
- Provides complete DDR DIMM solution with ICS98ULPA877A or IDTCSPUA877A
- Ideal for DDR2 400, 533, and 667

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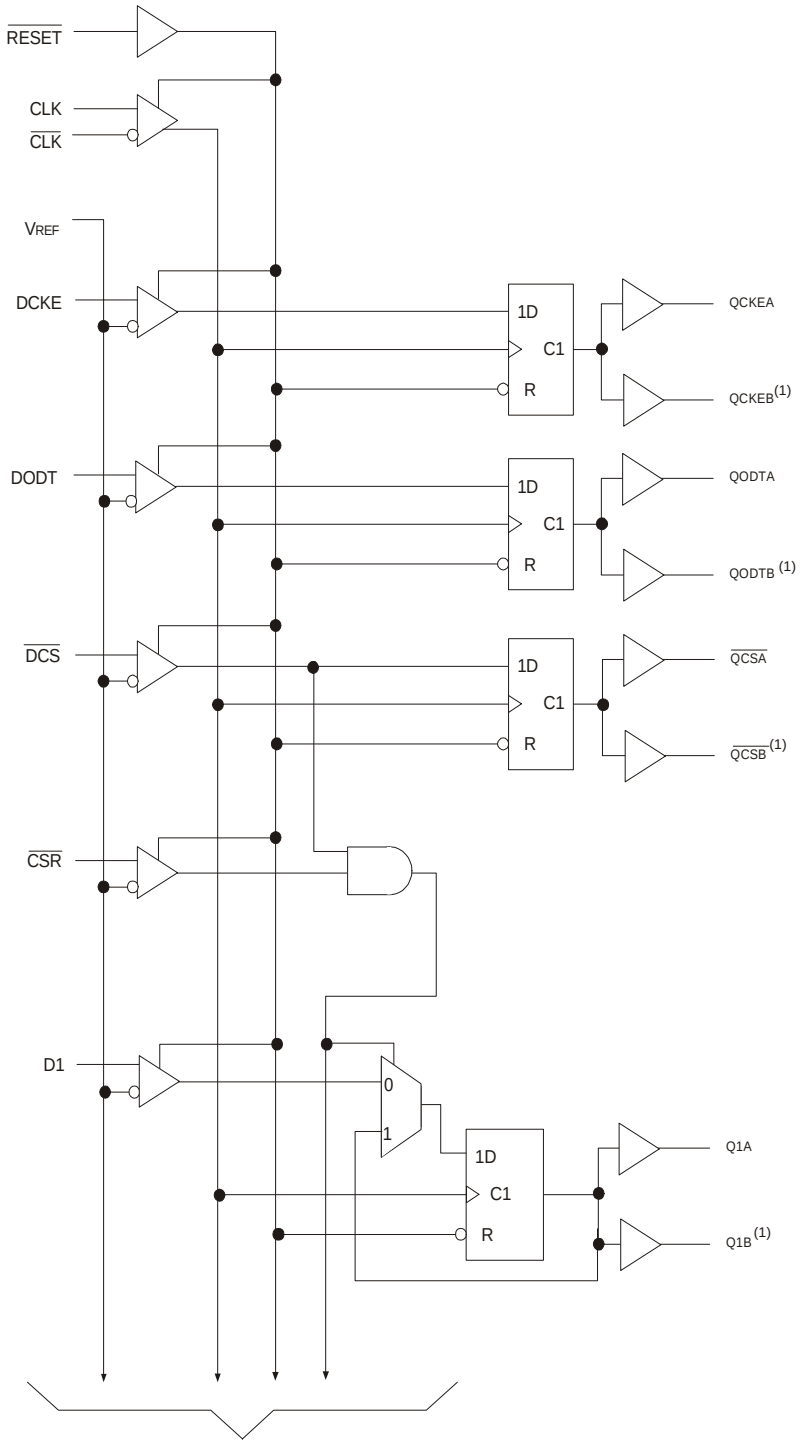
Functional Block Diagram for 1:1 Mode (Positive Logic)



NOTE:
1. Disabled in 1:1 configuration.

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Functional Block Diagram for 1:2 Mode (Positive Logic)



NOTE:
1. Disabled in 1:1 configuration.

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Pin Configurations

14 BIT 1:2 REGISTERS

	1	2	3	4	5	6
A	DCKE	PPO	VREF	VDD	QCKEA	QCKEB
B	D2	NC	GND	GND	Q2A	Q2B
C	D3	NC	VDD	VDD	Q3A	Q3B
D	DODT	$\overline{\text{QERR}}$	GND	GND	QODTA	QODTB
E	D5	NC	VDD	VDD	Q5A	Q5B
F	D6	NC	GND	GND	Q6A	Q6B
G	PAR_IN	$\overline{\text{RESET}}$	VDD	VDD	C1	C0
H	CLK	$\overline{\text{DCS}}$	GND	GND	$\overline{\text{QCSA}}$	$\overline{\text{QCSB}}$
J	$\overline{\text{CLK}}$	$\overline{\text{CSR}}$	VDD	VDD	ZOH	ZOL
K	D8	NC	GND	GND	Q8A	Q8B
L	D9	NC	VDD	VDD	Q9A	Q9B
M	D10	NC	GND	GND	Q10A	Q10B
N	D11	NC	VDD	VDD	Q11A	Q11B
P	D12	NC	GND	GND	Q12A	Q12B
R	D13	NC	VDD	VDD	Q13A	Q13B
T	D14	NC	VREF	VDD	Q14A	Q14B

REGISTER A (C0 = 0, C1 = 1)

	1	2	3	4	5	6
A	D1	PPO	VREF	VDD	Q1A	Q1B
B	D2	NC	GND	GND	Q2A	Q2B
C	D3	NC	VDD	VDD	Q3A	Q3B
D	D4	$\overline{\text{QERR}}$	GND	GND	Q4A	Q4B
E	D5	NC	VDD	VDD	Q5A	Q5B
F	D6	NC	GND	GND	Q6A	Q6B
G	PAR_IN	$\overline{\text{RESET}}$	VDD	VDD	C1	C0
H	CLK	$\overline{\text{DCS}}$	GND	GND	$\overline{\text{QCSA}}$	$\overline{\text{QCSB}}$
J	$\overline{\text{CLK}}$	$\overline{\text{CSR}}$	VDD	VDD	ZOH	ZOL
K	D8	NC	GND	GND	Q8A	Q8B
L	D9	NC	VDD	VDD	Q9A	Q9B
M	D10	NC	GND	GND	Q10A	Q10B
N	DODT	NC	VDD	VDD	QODTA	QODTB
P	D12	NC	GND	GND	Q12A	Q12B
R	D13	NC	VDD	VDD	Q13A	Q13B
T	DCKE	NC	VREF	VDD	QCKEA	QCKEB

REGISTER B (C0 = 1, C1 = 1)

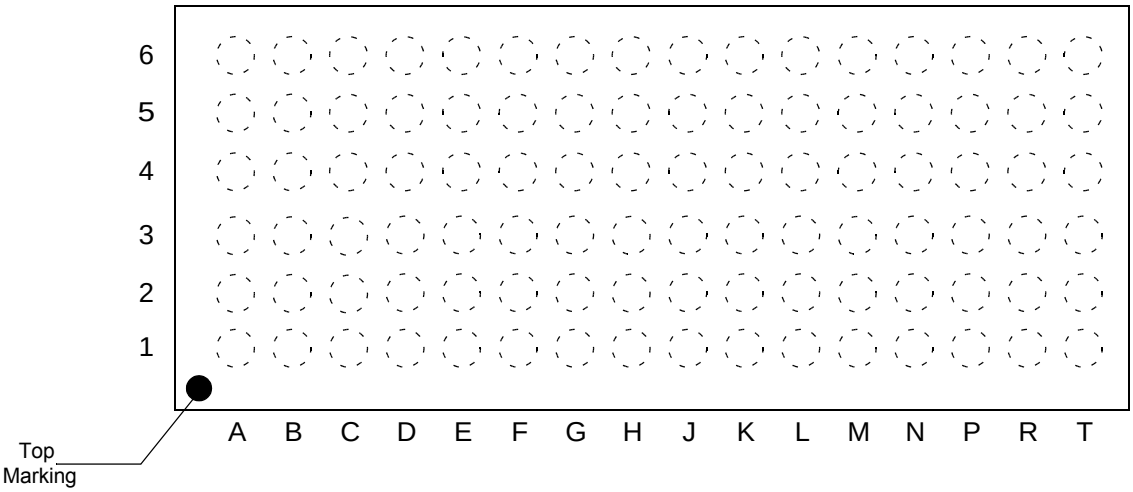
25 BIT 1:1 REGISTER

	1	2	3	4	5	6
A	DCKE	PPO	VREF	VDD	QCKE	NC
B	D2	D15	GND	GND	Q2	Q15
C	D3	D16	VDD	VDD	Q3	Q16
D	DODT	$\overline{\text{QERR}}$	GND	GND	QODT	NC
E	D5	D17	VDD	VDD	Q5	Q17
F	D6	D18	GND	GND	Q6	Q18
G	PAR_IN	$\overline{\text{RESET}}$	VDD	VDD	C1	C0
H	CLK	$\overline{\text{DCS}}$	GND	GND	$\overline{\text{QCS}}$	NC
J	$\overline{\text{CLK}}$	$\overline{\text{CSR}}$	VDD	VDD	ZOH	ZOL
K	D8	D19	GND	GND	Q8	Q19
L	D9	D20	VDD	VDD	Q9	Q20
M	D10	D21	GND	GND	Q10	Q21
N	D11	D22	VDD	VDD	Q11	Q22
P	D12	D23	GND	GND	Q12	Q23
R	D13	D24	VDD	VDD	Q13	Q24
T	D14	D25	VREF	VDD	Q14	Q25

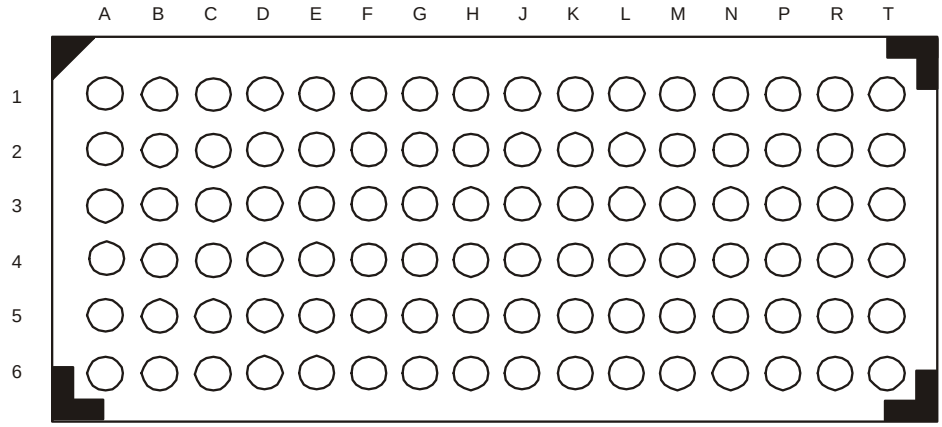
C0 = 0, C1 = 0

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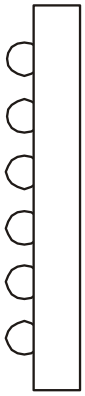
96 Ball LFBGA Package Attributes



TOP VIEW



BOTTOM VIEW



SIDE VIEW

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Function Table

Inputs[1]						Outputs		
$\overline{\text{RESET}}$	$\overline{\text{DCS}}$	$\overline{\text{CSR}}$	CLK	$\overline{\text{CLK}}$	Dn, DODT, DCKE	Qn	$\overline{\text{QCS}}$	QODT, QCKE
H	L	L	↑	↓	L	L	L	L
H	L	L	↑	↓	H	H	L	H
H	L	L	L or H	L or H	X	Q_0[2]	Q_0[2]	Q_0[2]
H	L	H	↑	↓	L	L	L	L
H	L	H	↑	↓	H	H	L	H
H	L	H	L or H	L or H	X	Q_0[2]	Q_0[2]	Q_0[2]
H	H	L	↑	↓	L	L	H	L
H	H	L	↑	↓	H	H	H	H
H	H	L	L or H	L or H	X	Q_0[2]	Q_0[2]	Q_0[2]
H	H	H	↑	↓	L	Q_0[2]	H	L
H	H	H	↑	↓	H	Q_0[2]	H	H
H	H	H	L or H	L or H	X	Q_0[2]	Q_0[2]	Q_0[2]
L	X or Floating	X or Floating	X or Floating	X or Floating	X or Floating	L	L	L

1 H = HIGH Voltage Level
L = LOW Voltage Level
X = Don't Care
↑ = LOW to HIGH
↓= HIGH to LOW

2 Output level before the indicated steady-state conditions were established.

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Parity and Standby Function Table

Inputs[1]							Outputs	
$\overline{\text{RESET}}$	$\overline{\text{DCS}}$	$\overline{\text{CSR}}$	CLK	$\overline{\text{CLK}}$	Σ of Inputs = H (D1 - D25)	PAR_IN[2]	$\overline{\text{PPO}}$	$\overline{\text{QERR}}$[3]
H	L	X	↑	↓	Even	L	L	H
H	L	X	↑	↓	Odd	L	H	L
H	L	X	↑	↓	Even	H	H	L
H	L	X	↑	↓	Odd	H	L	H
H	X	L	↑	↓	Even	L	L	H
H	X	L	↑	↓	Odd	L	H	L
H	X	L	↑	↓	Even	H	H	L
H	X	L	↑	↓	Odd	H	L	H
H	H	H	↑	↓	X	X	PPO_0	$\overline{QERR}_0$
H	X	X	L or H	L or H	X	X	PPO_0	$\overline{QERR}_0$
L	X or Floating	X or Floating	X or Floating	X or Floating	X or Floating	X or Floating	L	H

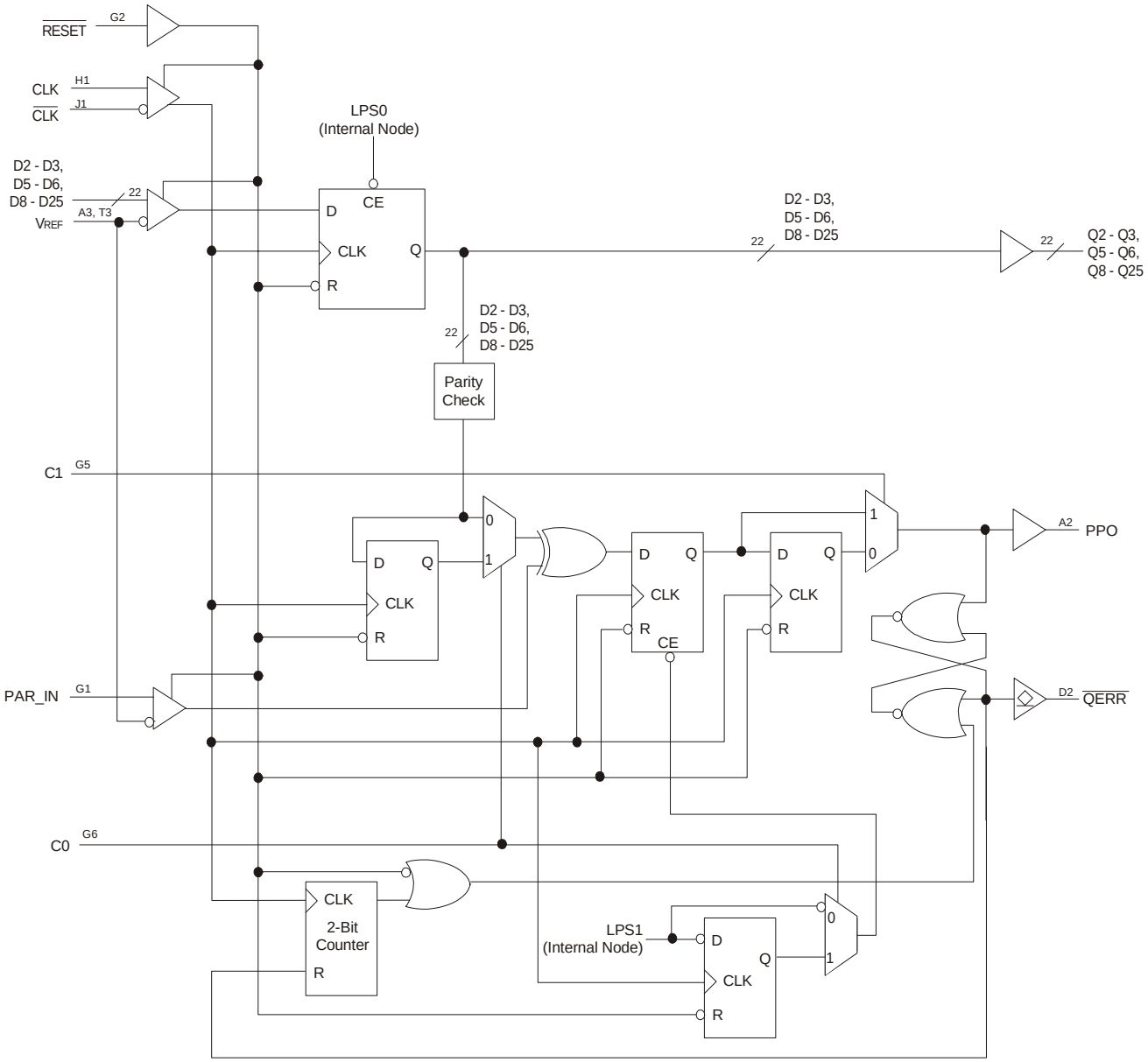
1 H = HIGH Voltage Level
L = LOW Voltage Level
X = Don't Care
↑ = LOW to HIGH
↓= HIGH to LOW
Data Inputs = D2, D3, D5, D6, D8 - D25 when C0 = 0 and C1 = 0.
Data Inputs = D2, D3, D5, D6, D8 - D14 when C0 = 0 and C1 = 1.
Data Inputs = D1 - D6, D8 - D10, D12, D13 when C0 = 1 and C1 = 1.

2 PAR_IN arrives one clock cycle after the data to which it applies when C0 = 0, and two clock cycles when C0 = 1.

3 This transition assumes $\overline{\text{QERR}}$ is HIGH at the crossing of CLK going HIGH and $\overline{\text{CLK}}$ going LOW. If $\overline{\text{QERR}}$ is LOW, it stays latched LOW for two clock cycles or until $\overline{\text{RESET}}$ is driven LOW.

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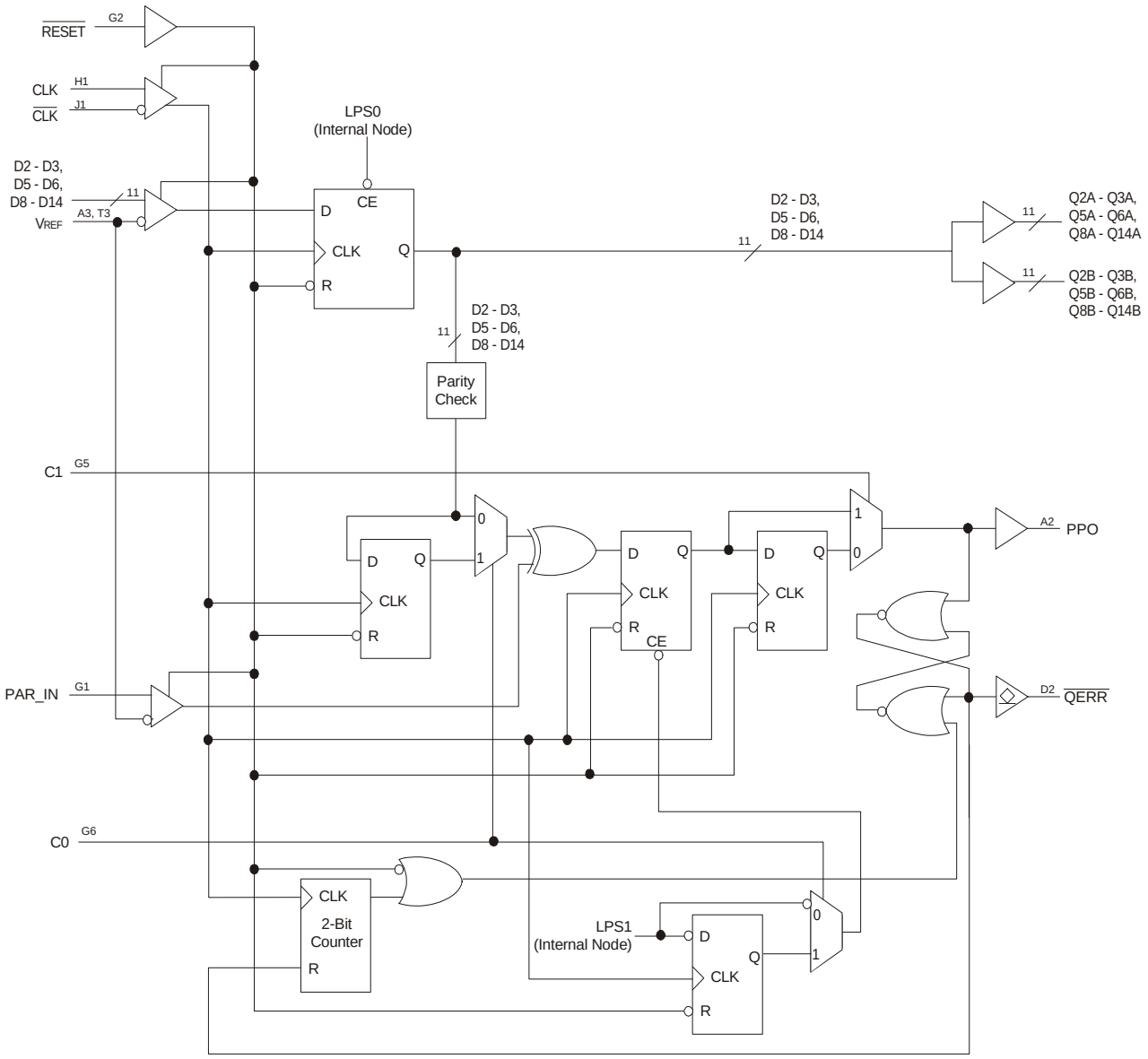
Logic Diagram (1:1)



Parity Logic Diagram for 1:1 Register Configuration (Positive Logic); C0 = 0, C1 = 0

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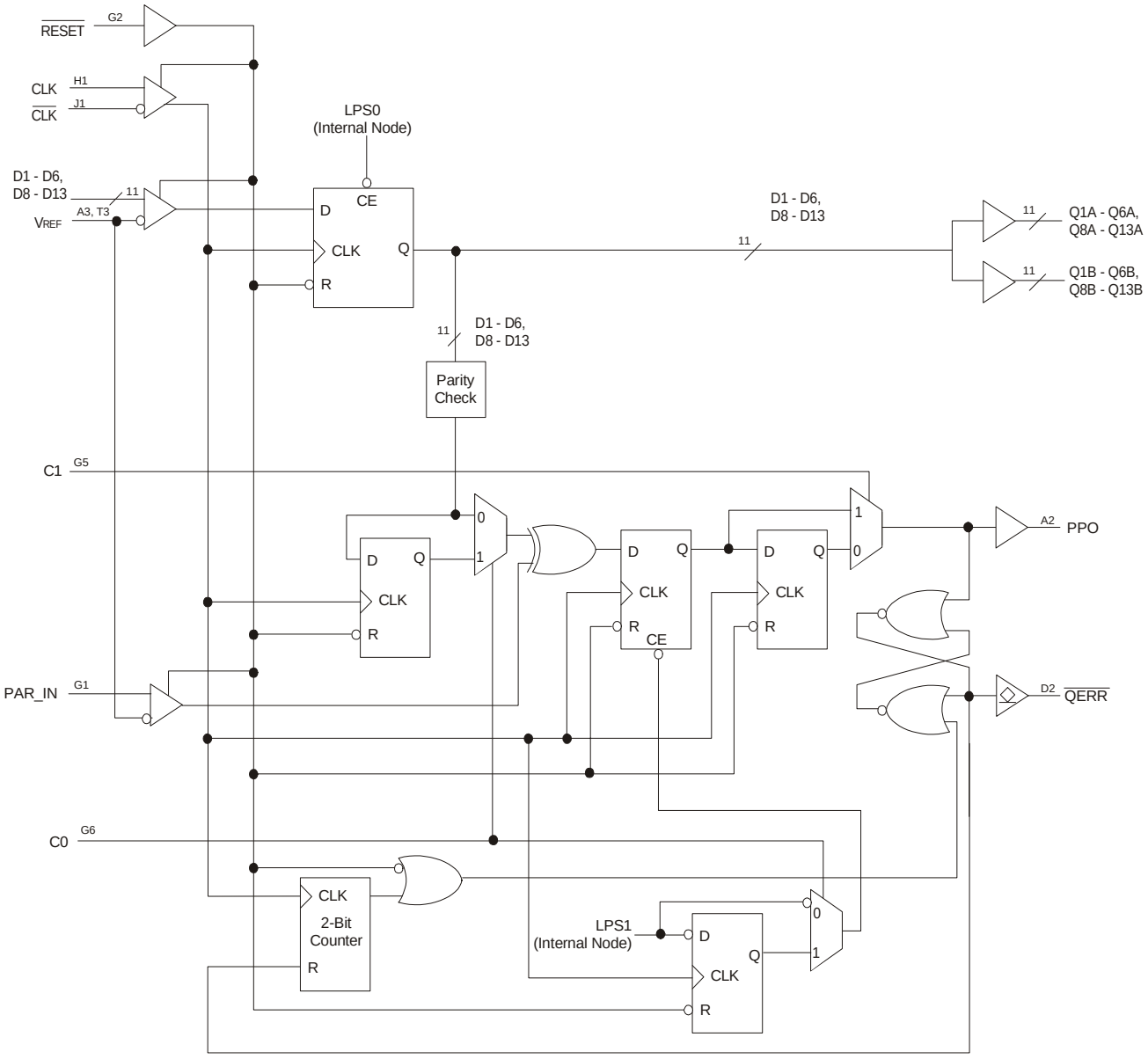
Logic Diagram (1:2)



Parity Logic Diagram for 1:2 Register - A Configuration (Positive Logic); C0 = 0, C1 = 1

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Logic Diagram (1:2)



Parity Logic Diagram for 1:2 Register - B Configuration (Positive Logic); C0 = 1, C1 = 1

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Absolute Maximum Ratings

Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Item		Rating
Supply Voltage, V_{DD}		-0.5V to 2.5V
Input Voltage Range, V_I[1]		-0.5V to 2.5V
Output Voltage Range, V_O[1,2]		-0.5V to V_{DD} + 0.5V
Input Clamp Current, I_{IK}		±50mA
Output Clamp Current, I_{OK}		±50mA
Continuous Output Clamp Current, I_O		±50mA
Continuous Current through each V_{DD} or GND		±100mA
Package Thermal Impedance (θja)[3]	0m/s Airflow	70.9° C/W
	1m/s Airflow	65° C/W
Storage Temperature		-65 to +150° C

1 The input and output negative voltage ratings may be exceeded if the ratings of the I/P and O/P clamp current are observed.
2 This current will flow only when the output is in the high state level $V_O > V_{DDQ}$.
3 The package thermal impedance is calculated in accordance with JESD 51.

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Terminal Functions

Terminal Name	Electrical Characteristics	Description
GND	Ground Input	Ground
V_{DD}	1.8V nominal	Power Supply Voltage
V_{REF}	0.9V nominal	Input Reference Clock
Z_{OH}	Input	Reserved for future use
Z_{OL}	Input	Reserved for future use
CLK	Differential Input	Positive Master Clock Input
$\overline{CLK}$	Differential Input	Negative Master Clock Input
C0, C1	LVCMOS Input	Configuration Control Inputs
$\overline{RESET}$	LVCMOS Input	Asynchronous Reset Input. Resets registers and disables V_{REF} data and clock differential-input receivers.
$\overline{CSR}$, $\overline{DCS}$	SSTL_18 Input	Chip Select Inputs. Disables outputs D1 - D24 output switching when both inputs are HIGH.
D1 - D25	SSTL_18 Input	Data Input. Clocked in on the crossing of the rising edge of CLK and the falling edge of $\overline{CLK}$.
DODT	SSTL_18 Input	The outputs of this register bit will not be suspended by the $\overline{DCS}$ and $\overline{CSR}$ controls
DCKE	SSTL_18 Input	The outputs of this register bit will not be suspended by the $\overline{DCS}$ and $\overline{CSR}$ controls
Q1 - Q25	1.8V CMOS	Data Outputs that are suspended by the $\overline{DCS}$ and $\overline{CSR}$ controls
$\overline{QCS}$	1.8V CMOS	Data Output that will not be suspended by the $\overline{DCS}$ and $\overline{CSR}$ controls
QODT	1.8V CMOS	Data Output that will not be suspended by the $\overline{DCS}$ and $\overline{CSR}$ controls
QCKE	1.8V CMOS	Data Output that will not be suspended by the $\overline{DCS}$ and $\overline{CSR}$ controls
PPO	1.8V CMOS	Partial Parity Output. Indicates off parity of D1 - D25
PAR_IN	SSTL_18 Input	Parity Input arrives one cycle after corresponding data input
$\overline{QERR}$	Open Drain Output	Output Error bit, generated one cycle after the corresponding data output

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Operating Characteristics

The $\overline{\text{RESET}}$ and Cn inputs of the device must be held at valid levels (not floating) to ensure proper device operation. The differential inputs must not be floating unless $\overline{\text{RESET}}$ is LOW.

Symbol	Parameter		Min.	Typ.	Max.	Units
V_{DDQ}	I/O Supply Voltage		1.7		1.9	V
V_{REF}	Reference Voltage		0.49 * V_{DD}	0.5 * V_{DD}	0.51 * V_{DD}	V
V_{TT}	Termination Voltage		V_{REF} - 0.04	V_{REF}	V_{REF} + 0.04	V
V_I	Input Voltage		0		V_{DD}	V
V_{IH}	AC High-Level Input Voltage	Data, $\overline{\text{CSR}}$, and PAR_IN inputs	V_{REF} + 0.25			V
V_{IL}	AC Low-Level Input Voltage				V_{REF} - 0.25	
V_{IH}	DC High-Level Input Voltage		V_{REF} + 0.125			
V_{IL}	DC Low-Level Input Voltage				V_{REF} - 0.125	
V_{IH}	High-Level Input Voltage	$\overline{\text{RESET}}$, C0, C1	0.65 * V_{DDQ}			V
V_{IL}	Low-Level Input Voltage				0.35 * V_{DDQ}	
V_{ICR}	Common Mode Input Range	CLK, $\overline{\text{CLK}}$	0.675		1.125	V
V_{ID}	Differential Input Voltage		600			mV
I_{OH}	High-Level Output Current				-8	mA
I_{OL}	Low-Level Output Current				8	
I_{ERROL}	$\overline{\text{QERR}}$ LOW Level Output Current		25			mA
T_A	Operating Free-Air Temperature		0		+70	°C

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DC Electrical Characteristics Over Operating Range

Following Conditions Apply Unless Otherwise Specified:

Operating Condition: T_A = 0°C to +70°C, V_{DD} = 1.7V to 1.9V.

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units
V_{IK}		I_I = -18mA				-1.2	V
V_{OH}	Output HIGH Voltage	I_{OH} = -6mA		1.2			V
V_{OL}	Output LOW Voltage	I_{OL} = 6mA				0.5	V
V_{ERROL}	$\overline{QERR}$ Output LOW Voltage	I_{ERROL} = 25mA, V_{DD} = 1.7V				0.5	V
I_{IL}	All Inputs	V_I = V_{DD} or GND; V_{DD} = 1.9V		-5		+5	µA
I_{DD}	Static Standby	I_O = 0, V_{DD} = 1.9V, $\overline{RESET}$ = GND				100	µA
	Static Operating	I_O = 0, V_{DD} = 1.9V, $\overline{RESET}$ = V_{DD}, V_I = $V_{IH(AC)}$ or $V_{IL(AC)}$, CLK = $\overline{CLK}$ = $V_{IH(AC)}$ or $V_{IL(AC)}$				10	mA
		I_O = 0, V_{DD} = 1.9V, $\overline{RESET}$ = V_{DD}, V_I = $V_{IH(AC)}$ or $V_{IL(AC)}$, CLK = $V_{IH(AC)}$, $\overline{CLK}$ = $V_{IL(AC)}$			100		
I_{DDD}	Dynamic Operating (clock only)	I_O = 0, V_{DD} = 1.8V, $\overline{RESET}$ = V_{DD}, V_I = $V_{IH(AC)}$ or $V_{IL(AC)}$, CLK and $\overline{CLK}$ switching 50% duty cycle			210		µA/Clock MHz
	Dynamic Operating (per each data input)	I_O = 0, V_{DD} = 1.8V, $\overline{RESET}$ = V_{DD}, V_I = $V_{IH(AC)}$ or $V_{IL(AC)}$, CLK and $\overline{CLK}$ switching 50% duty cycle. One data input switching at half clock frequency, 50% duty cycle.	1:1 mode		70		µA/Clock MHz/ Data Input
			1:2 mode		120		
C_{IN}	Data Inputs	V_I = V_{REF} ± 350mV		2		3	pF
	CLK and $\overline{CLK}$	V_{ICR} = 1.25V, V_{IPP} = 360mV		2		3	
	$\overline{RESET}$	V_I = V_{DD} or GND			5		

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Timing Requirements Over Recommended Operating Free-Air Temperature Range

Symbol	Parameter		V_{DD} = 1.8V ± 0.1V Min.	V_{DD} = 1.8V ± 0.1V Max.	Units
f_{CLOCK}	Clock Frequency			410	MHz
t_W	Pulse Duration, CLK, $\overline{CLK}$ HIGH or LOW		1		ns
t_{ACT}[1]	Differential Inputs Active Time			10	ns
t_{INACT}[2]	Differential Inputs Inactive Time			15	ns
t_{SU}	Setup Time	$\overline{DCS}$ before CLK↑ , $\overline{CLK}$↓, $\overline{CSR}$ HIGH; $\overline{CSR}$ before CLK↑ , $\overline{CLK}$↓, $\overline{DCS}$ HIGH	0.7		ns
		$\overline{DCS}$ before CLK↑ , $\overline{CLK}$↓, $\overline{CSR}$ LOW	0.5		
		DODT, DOCKE, and data before CLK↑ , $\overline{CLK}$↓	0.5		
		PAR_IN before CLK↑ , $\overline{CLK}$↓	0.5		
t_H	Hold Time	$\overline{DCS}$, DODT, DCKE, and data after CLK↑ , $\overline{CLK}$↓	0.5		ns
		PAR_IN after CLK↑ , $\overline{CLK}$↓	0.5		

1 V_{REF} must be held at a valid input voltage level and data inputs must be held at valid logic levels for a minimum time of t_{ACT}(max) after $\overline{RESET}$ is taken HIGH.
2 V_{REF}, data, and clock inputs must be held at a valid input voltage levels (not floating) for a minimum time of t_{INACT}(max) after $\overline{RESET}$ is taken LOW.

Switching Characteristics Over Recommended Free Air Operating Range (unless otherwise noted)

Symbol	Parameter	V_{DD} = 1.8V ± 0.1V Min.	V_{DD} = 1.8V ± 0.1V Max.	Units
f_{MAX}	Max Input Clock Frequency	410		MHz
t_{PDM}	Propagation Delay, single bit switching, CLK↑ / $\overline{CLK}$↓to Qn	1.3	1.9	ns
t_{PDMSS}	Propagation Delay, simultaneous switching, CLK↑ / $\overline{CLK}$↓to Qn		2	ns
t_{PD}	Propagation Delay, CLK↑ / $\overline{CLK}$↓to PPO	0.5	1.7	ns
t_{LH}	LOW to HIGH Propagation Delay, CLK↑ / $\overline{CLK}$↓to $\overline{QERR}$	0.9	3	ns
t_{HL}	HIGH to LOW Propagation Delay, CLK↑ / $\overline{CLK}$↓to $\overline{QERR}$	0.9	2.4	ns
t_{PHL}	HIGH to LOW Propagation Delay, $\overline{RESET}$↓to PPO to Qn↓		3	ns
t_{PLH}	LOW to HIGH Propagation Delay, $\overline{RESET}$↓to $\overline{QERR}$↑		3	ns

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Output Buffer Characteristics

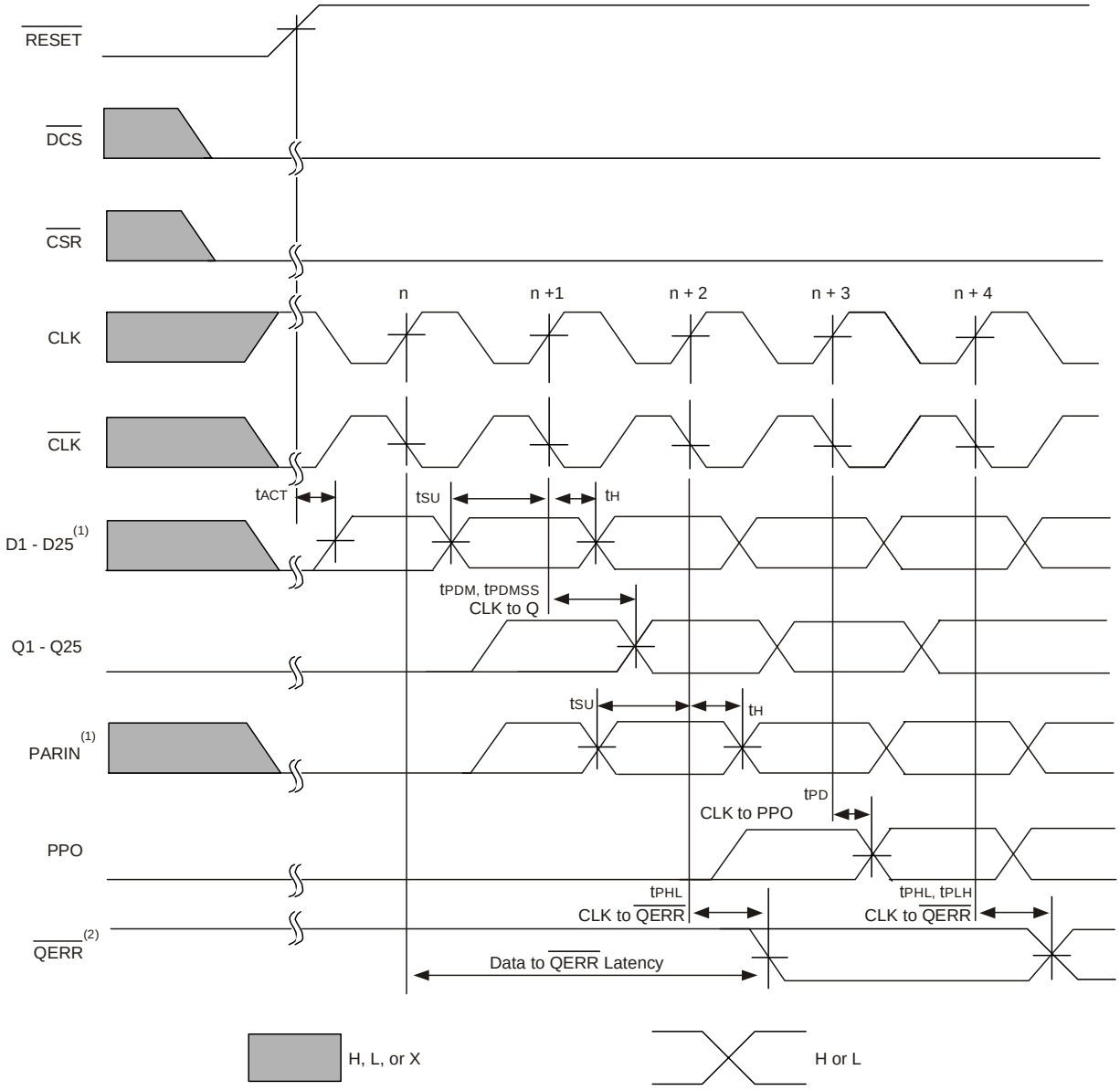
Output edge rates over recommended operating free-air temperature range

Parameter	V_{DD} = 1.8V ± 0.1V		Units
	Min.	Max.	
dV/dt_r	1	4	V/ns
dV/dt_f	1	4	V/ns
dV/dt_Δ[1]		1	V/ns

1 Difference between dV/dt_r (rising edge rate) and dV/dt_f (falling edge rate).

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Register Timing

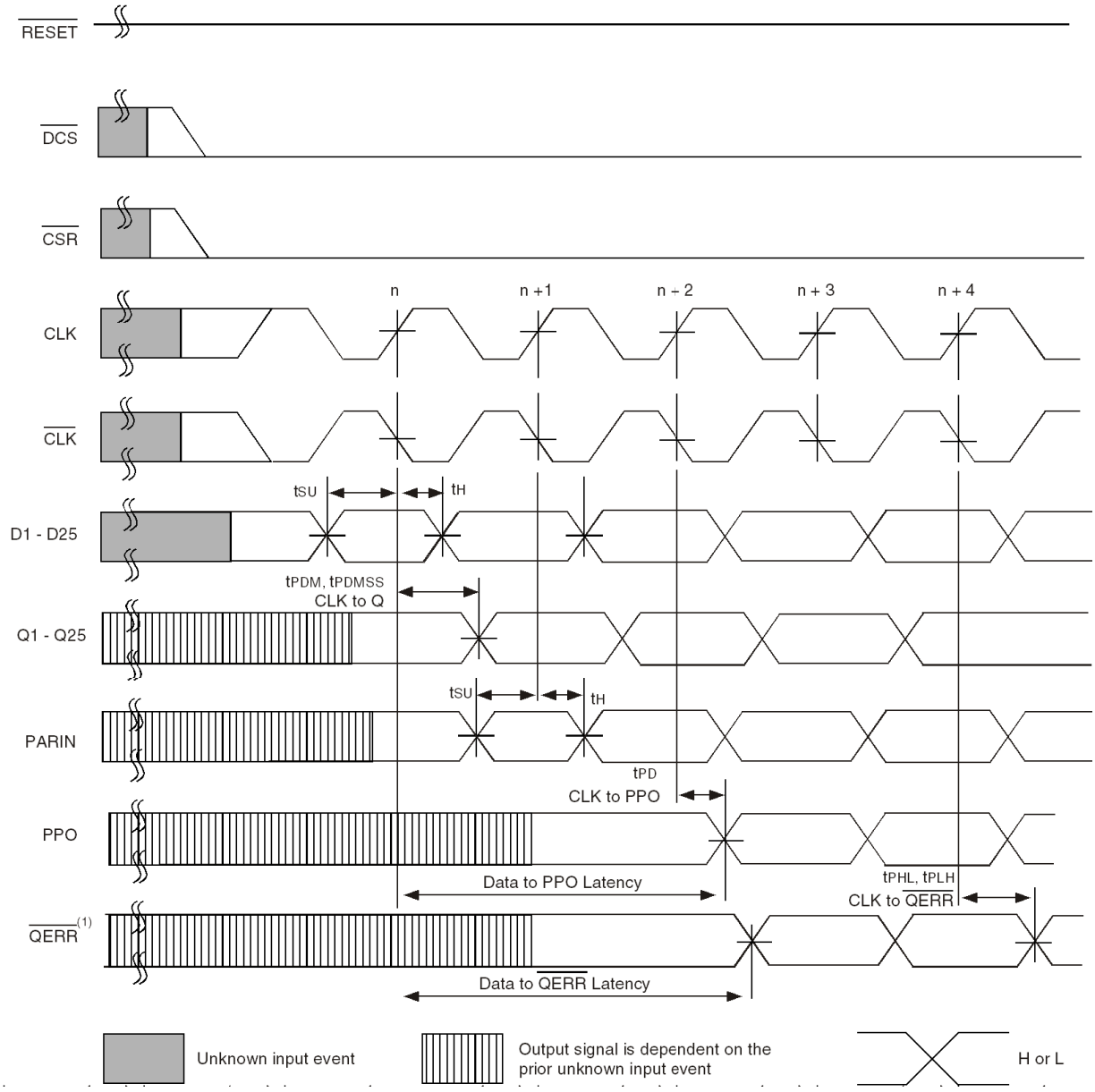


Timing Diagram for SSTUAF32866C Used as a Single Device; C0 = 0, C1 = 0, RESET Switches from L to H

NOTES:
1.After RESET is switched from LOW to HIGH, all data and PAR_IN inputs signals must be set and held low for a minimum time of tACTMAX, to avoid false error.
2.If the data is clocked in on the n clock pulse, the QERR output signal will be generated on the n+2 clock pulse, and it will be valid on the n+3 clock pulse.

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Register Timing

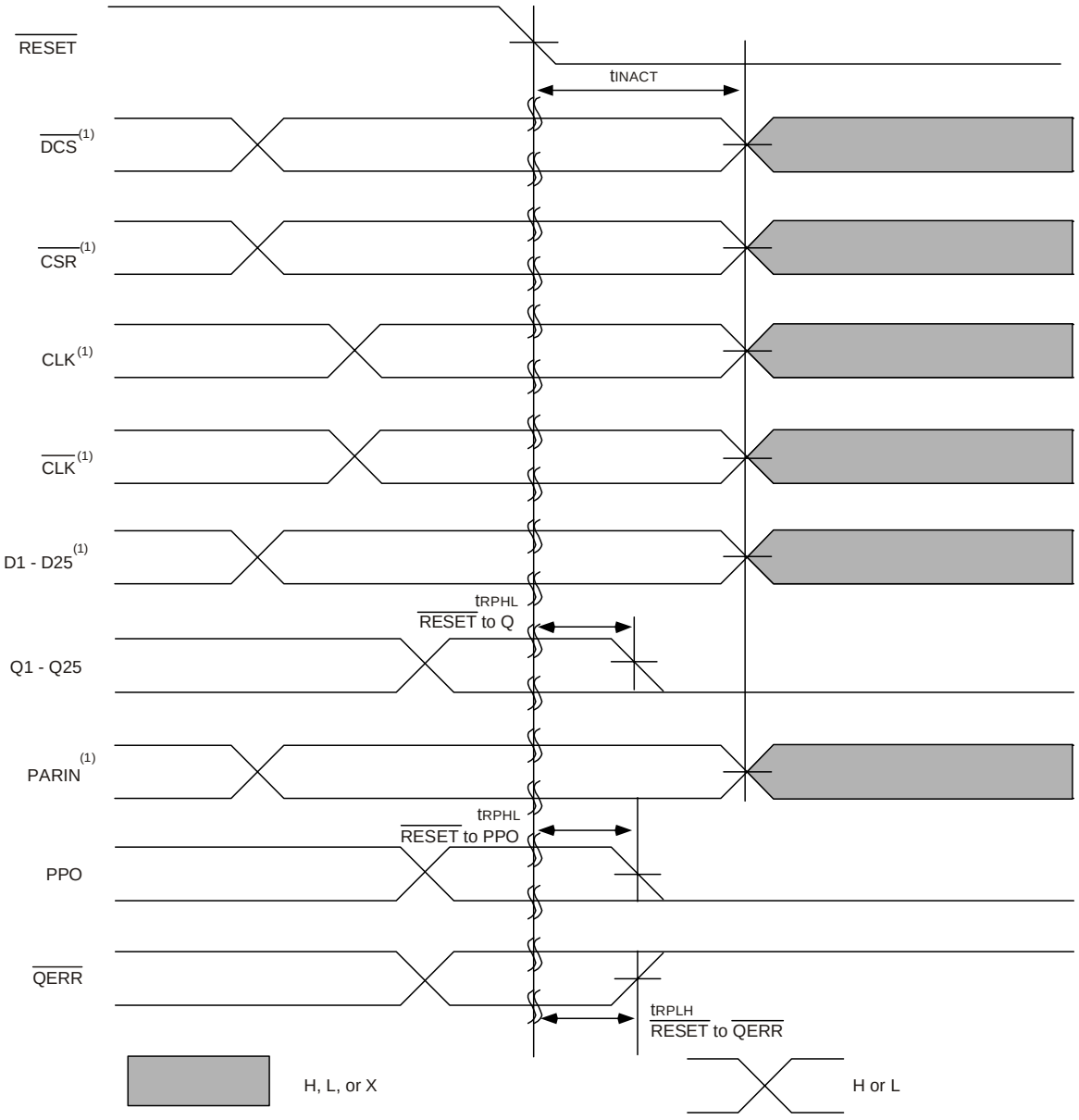


Timing Diagram for the First SSTUAF32866C Used as a Single Device; C0 = 0, C1 = 0, $\overline{\text{RESET}}$ Held HIGH

NOTE:
1.If the data is clocked in on the n clock pulse, the $\overline{\text{QERR}}$ output signal will be generated on the n+2 clock pulse, and it will be valid on the n+3 clock pulse. If an error occurs and the $\overline{\text{QERR}}$ output is driven low, it stays latched low for a minimum of two clock cycles or until $\overline{\text{RESET}}$ is driven low.

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Register Timing

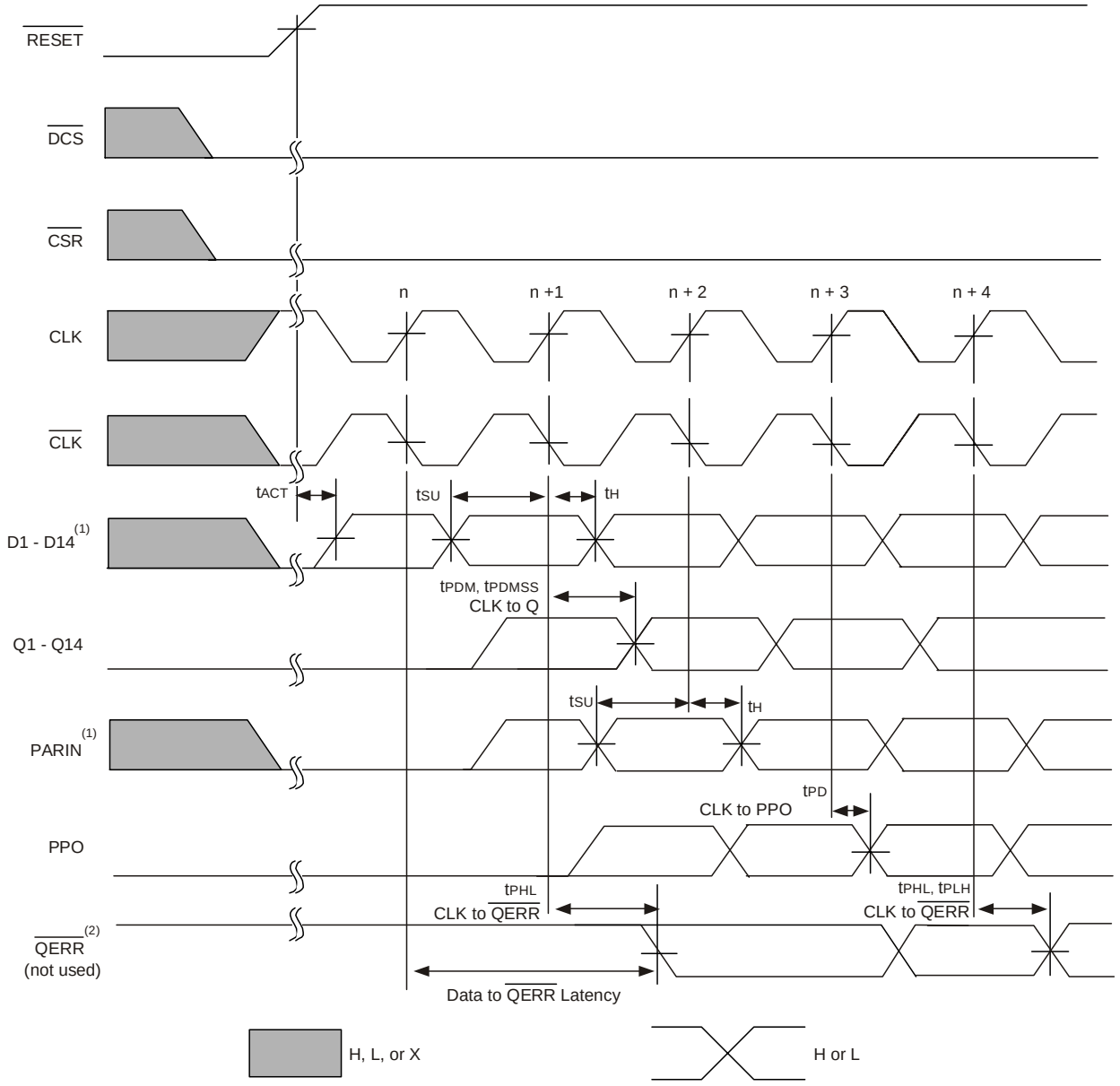


Timing Diagram for SSTUAF32866C Used as a Single Device; C0 = 0, C1 = 0, RESET Switches from H to L

NOTE:
1.After RESET is switched from HIGH to LOW, all data and clock inputs signals must be set and held at valid logic levels (not floating) for a minimum time of tINACTMAX.

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Register Timing

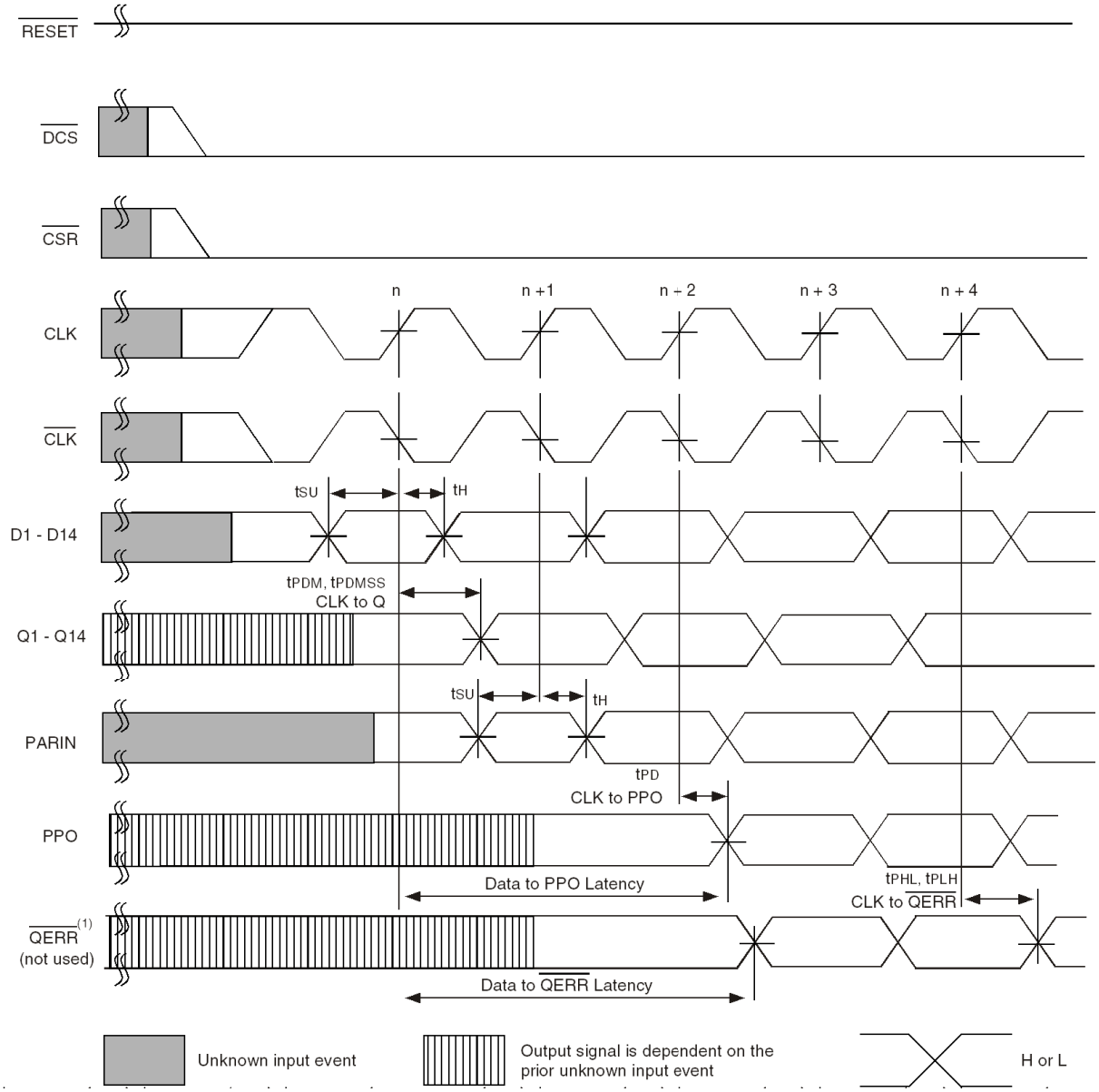


Timing Diagram for the First SSTUAF32866C (1:2 Register-A Configuration) Device Used in a Pair; C0 = 0, C1 = 1, RESET Switches from Lto H

NOTES:
1.After RESET is switched from LOW to HIGH, all data and PAR_IN inputs signals must be set and held low for a minimum time of tACTMAX, to avoid false error.
2.If the data is clocked in on the n clock pulse, the QERR output signal will be generated on the n+1 clock pulse, and it will be valid on the n+2 clock pulse.
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Register Timing

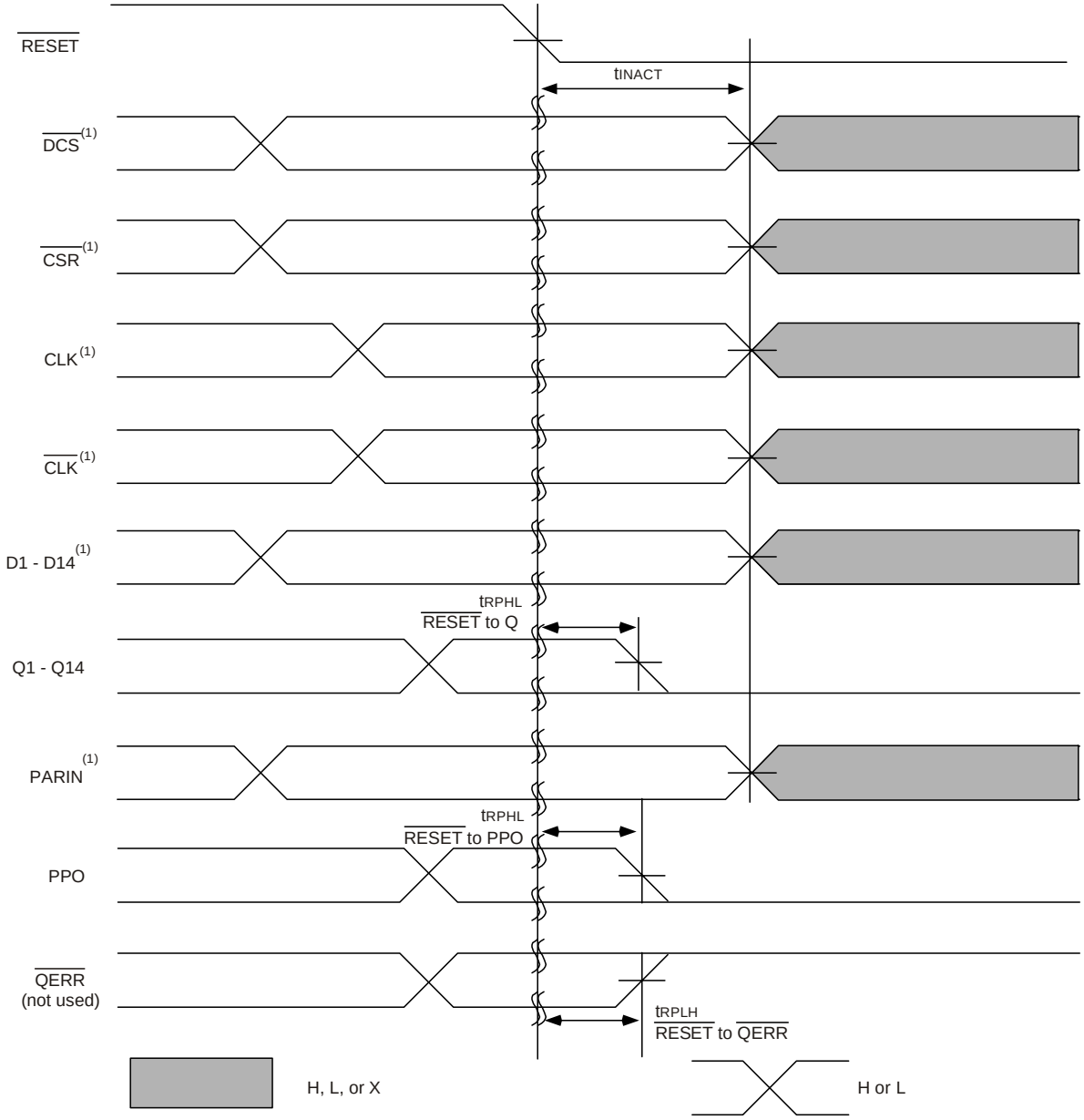


Timing Diagram for the First SSTUAF32866C (1:2 Register-A Configuration) Device Used in a Pair; C0 = 0, C1 = 1, RESET Held HIGH

NOTE:
1.If the data is clocked in on the n clock pulse, the QERR output signal will be generated on the n+1 clock pulse, and it will be valid on the n+2 clock pulse. If an error occurs and the QERR output is driven low, it stays latched low for a minimum of two clock cycles or until RESET is driven low.

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Register Timing

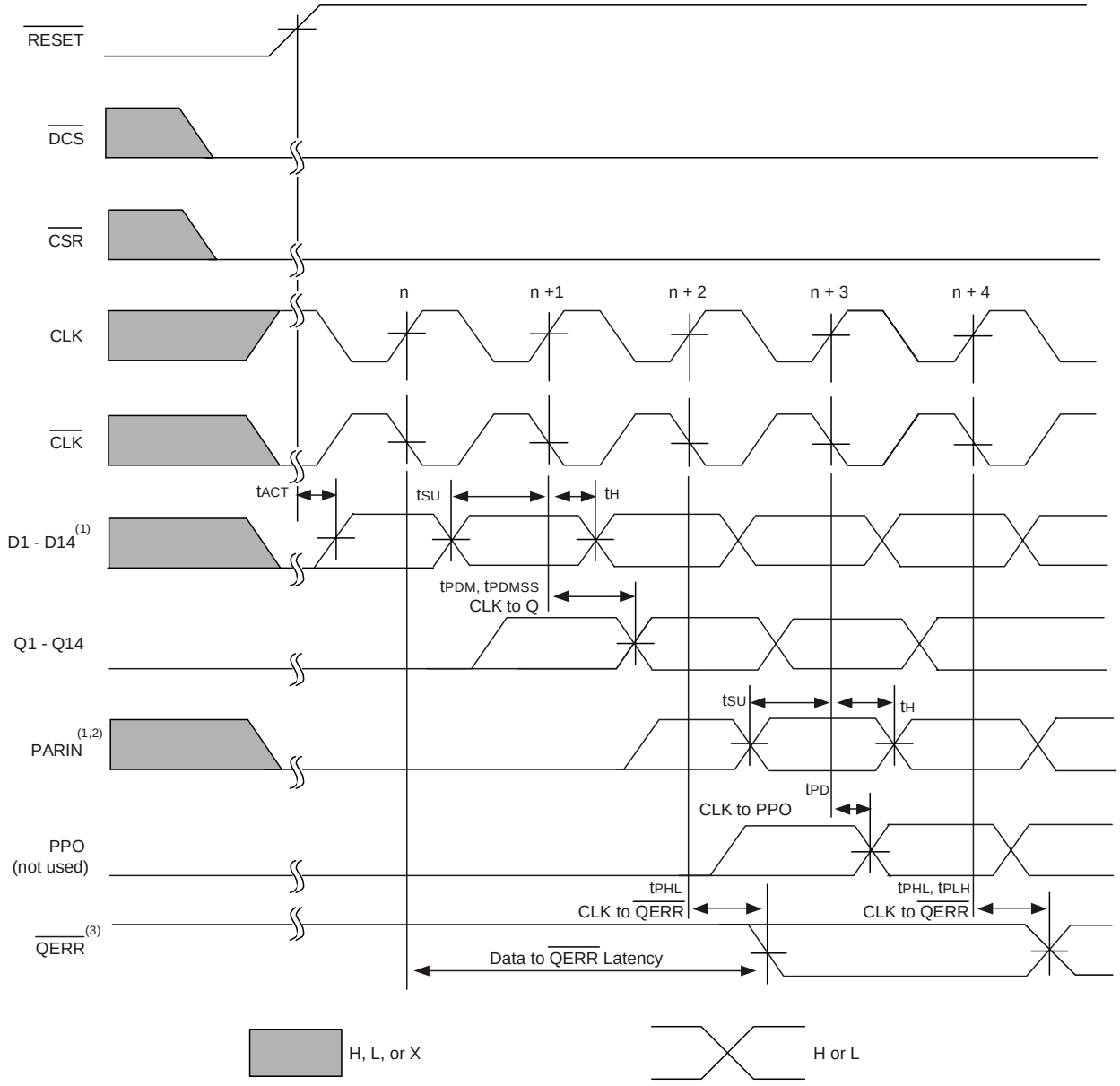


Timing Diagram for the First SSTUAF32866C (1:2 Register-A Configuration) Device Used in a Pair; C0 = 1, C1 = 1; RESET Switches from H to L

NOTE:
1.After RESET is switched from HIGH to LOW, all data and clock inputs signals must be set and held at valid logic levels (not floating) for a minimum time of tINACTMAX.

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Register Timing

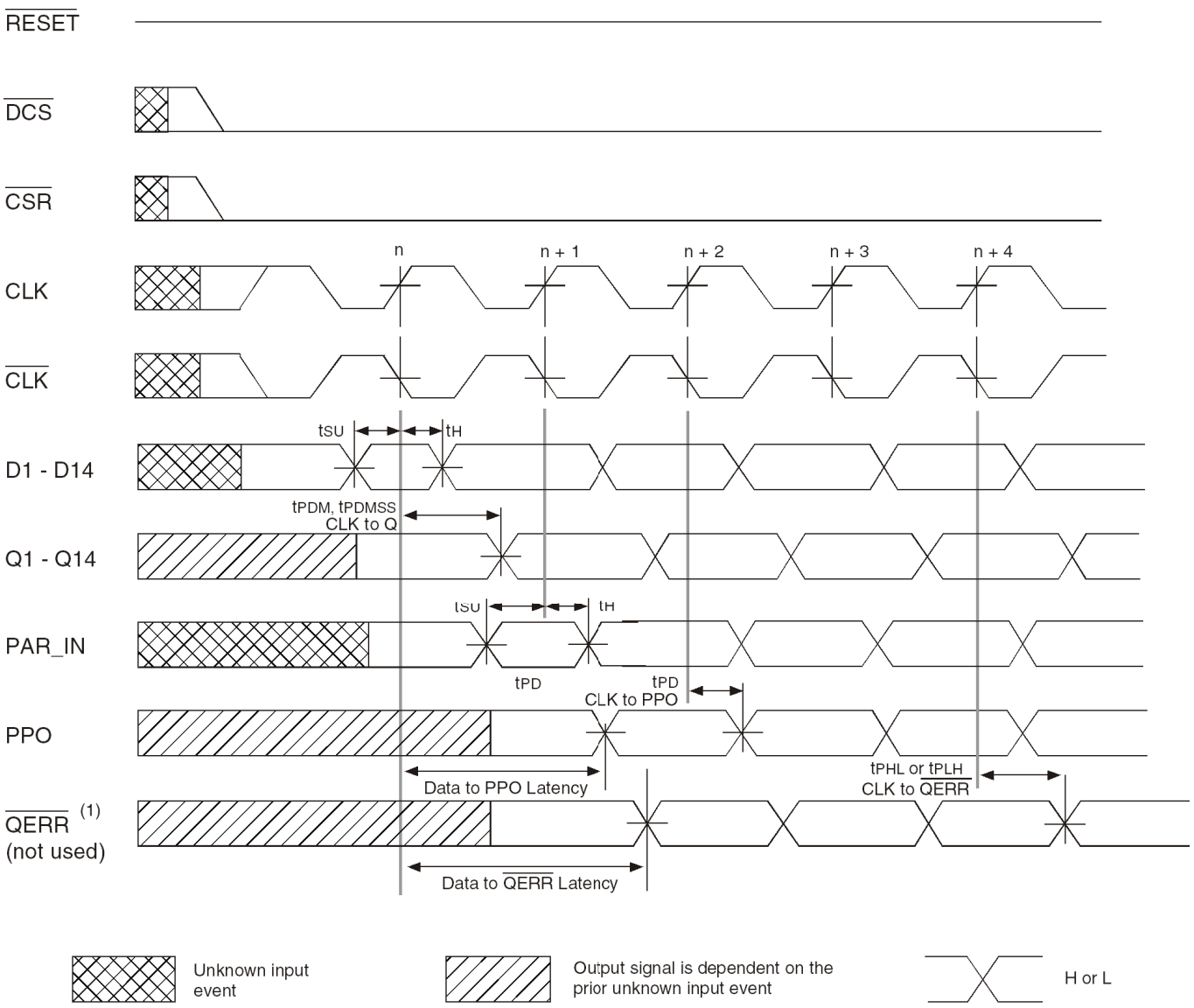


Timing Diagram for the Second SSTUAF32866C (1:2 Register-B Configuration) Device Used in a Pair; C0 = 1, C1 = 1, RESET Switches from L to H

NOTES:
1.After RESET is switched from LOW to HIGH, all data and PAR_IN inputs signals must be set and held low for a minimum time of tactmax, to avoid false error.
2.PAR_IN is driven from PPO of the first SSTUAF32866 device.
3.If the data is clocked in on the n clock pulse, the QERR output signal will be generated on the n+2 clock pulse, and it will be valid on the n+3 clock pulse.

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Register Timing

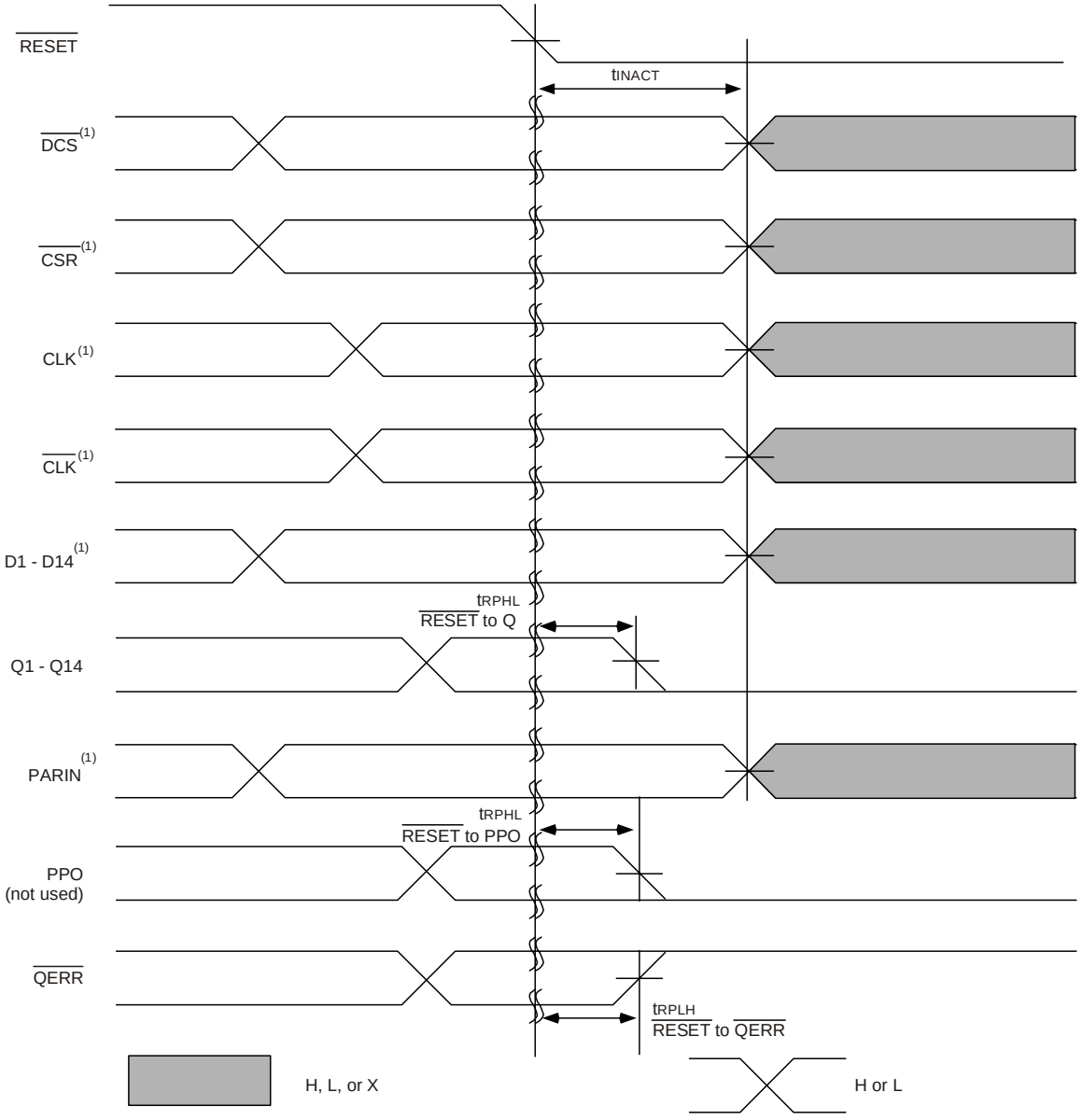


Timing Diagram for the Second SSTUAF32866C (1:2 Register-B Configuration) Device Used in a Pair; C0 = 1, C1 = 1, RESET Held HIGH

NOTES:
1.If the data is clocked in on the n clock pulse, the QERR output signal will be generated on the n+1 clock pulse, and it will be valid on the n+2 clock pulse. If an error occurs and the QERR output is driven low, it stays latched low for a minimum of two clock cycles or until RESET is driven low.
2.PAR_IN is driven from PPO of the first SSTUAF32866 device.

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Register Timing

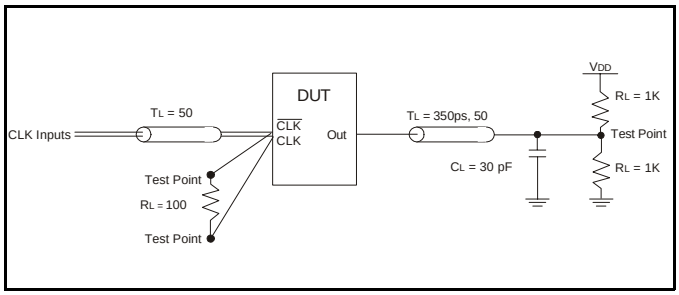


Timing Diagram for the First SSTUAF32866C (1:2 Register-A Configuration) Device Used in a Pair; C0 = 1, C1 = 1; RESET Switches from H to L

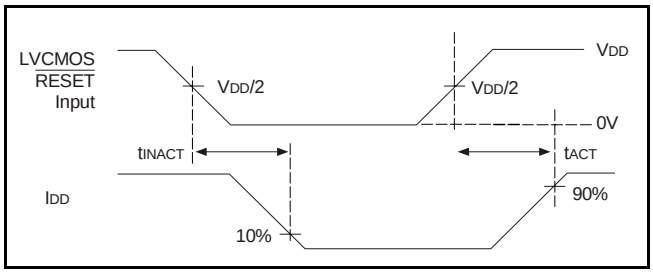
NOTE:
1.After RESET is switched from HIGH to LOW, all data and clock inputs signals must be set and held at valid logic levels (not floating) for a minimum time of $t_{INACTMAX}$.

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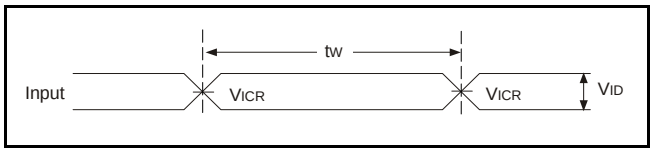
Test Circuits and Waveforms (V_{DD} = 1.8V ± 0.1V)



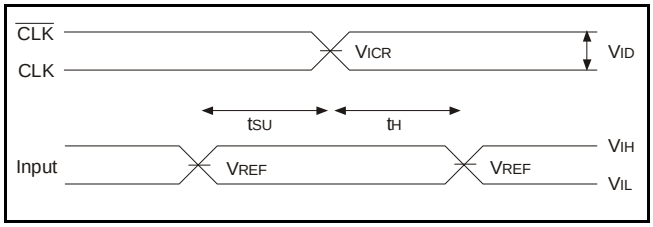
Simulation Load Circuit



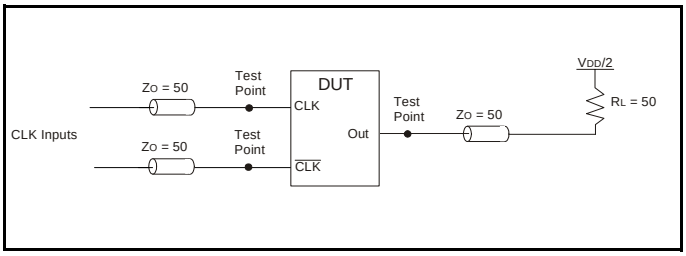
Voltage and Current Waveforms Inputs Active and Inactive Times



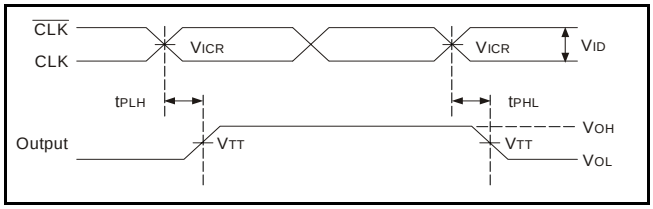
Voltage Waveforms - Pulse Duration



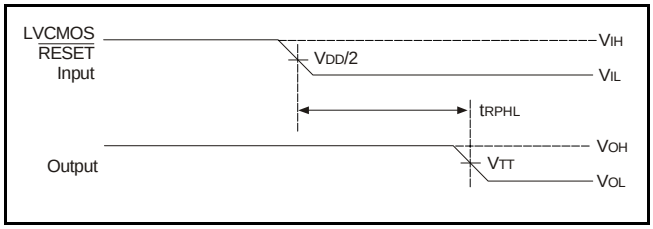
Voltage Waveforms - Setup and Hold Times



Production-Test Load Circuit



Voltage Waveforms - Propagation Delay Times

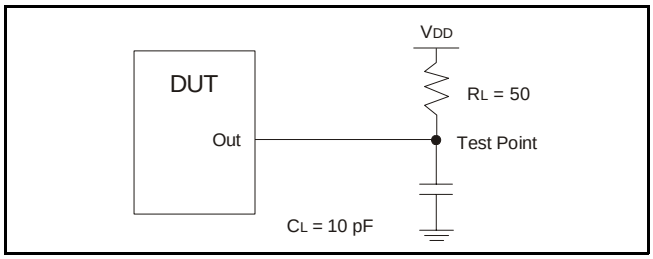


Voltage Waveforms - Propagation Delay Times

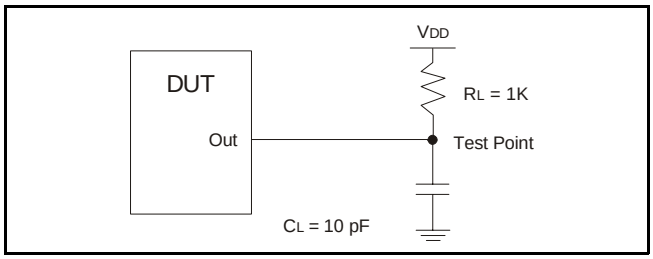
NOTES:
1. C_L includes probe and jig capacitance.
2. I_{DD} tested with clock and data inputs held at V_{DD} or GND, and Io = 0mA
3. All input pulses are supplied by generators having the following characteristics: PRR ≤10MHz, Zo = 50Ω, input slew rate = 1 V/ns ±20% (unless otherwise specified).
4. The outputs are measured one at a time with one transition per measurement.
5. $V_{TT} = V_{REF} = V_{DD}/2$
6. $V_{IH} = V_{REF}$ + 250mV (AC voltage levels) for differential inputs. $V_{IH} = V_{DD}$ for LVCMOS input.
7. $V_{IL} = V_{REF}$ - 250mV (AC voltage levels) for differential inputs. V_{IL} = GND for LVCMOS input.
8. V_{ID} = 600mV.
9. t_{PLH} and t_{PHL} are the same as t_{PDM}.

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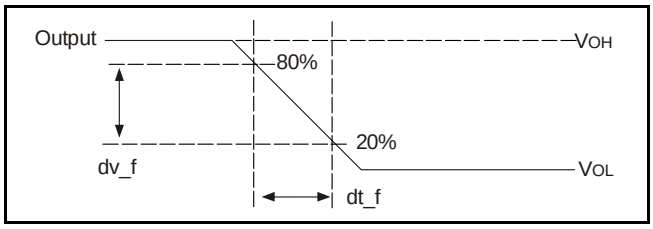
Test Circuits and Waveforms (V_{DD} = 1.8V ± 0.1V)



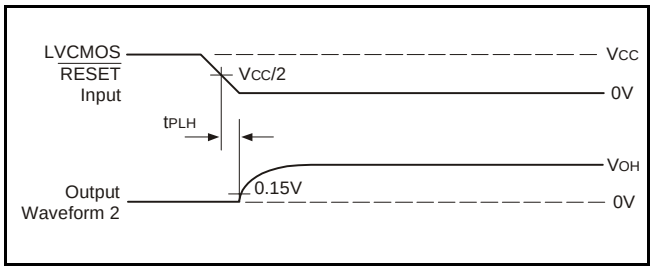
Load Circuit: High-to-Low Slew-Rate Adjustment



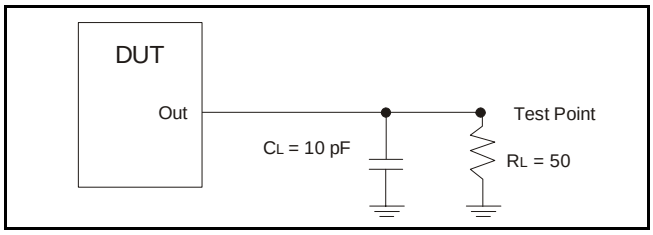
Load Circuit: Error Output Measurements



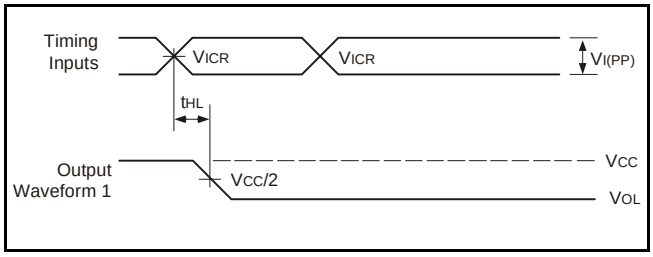
Voltage Waveforms: High-to-Low Slew-Rate Adjustment



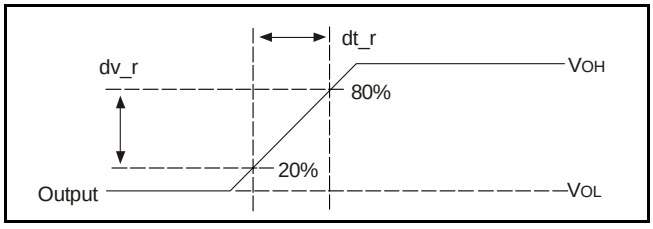
Voltage Waveforms: Open Drain Output Low-to-High Transition Time (with respect to $\overline{\text{RESET}}$ input)



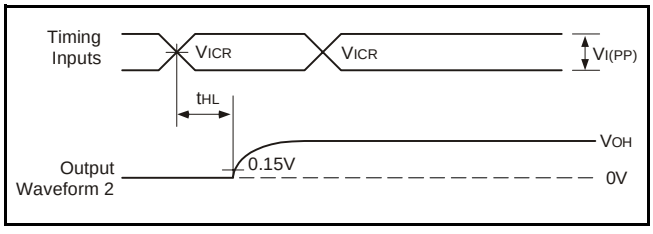
Load Circuit: Low-to-High Slew-Rate Adjustment



Voltage Waveforms: Open Drain Output High-to-Low Transition Time (with respect to clock inputs)



Voltage Waveforms: Low-to-High Slew-Rate Adjustment



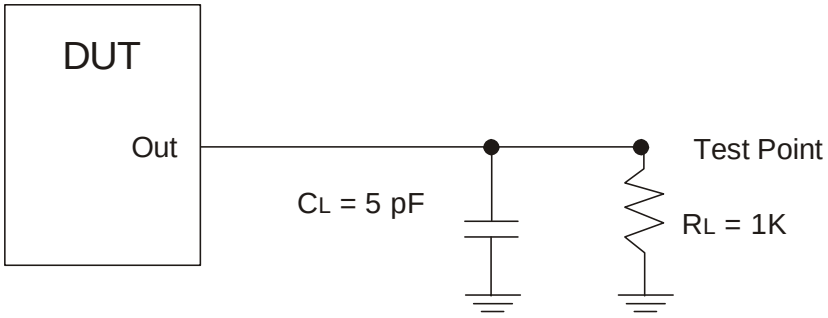
Voltage Waveforms: Open Drain Output Low-to-High Transition Time (with respect to clock inputs)

NOTES:

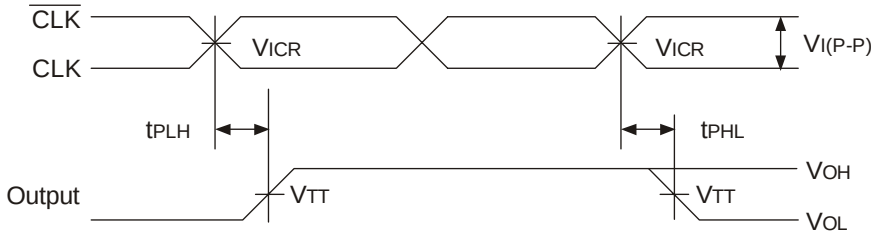
1. CL includes probe and jig capacitance.
2. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10MHz, Zo = 50Ω, input slew rate = 1 V/ns ±20% (unless otherwise specified).

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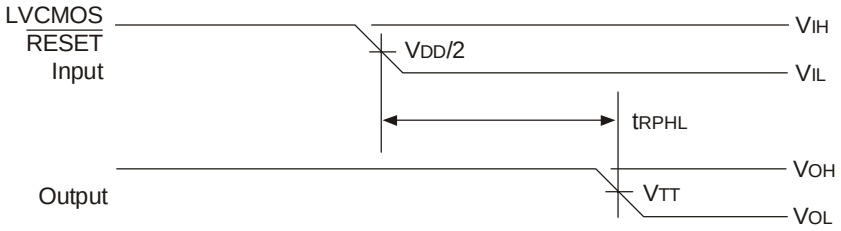
Test Circuits and Waveforms (V_{DD} = 1.8V ± 0.1V)



Load Circuit: Partial-Parity-Out Load Circuit



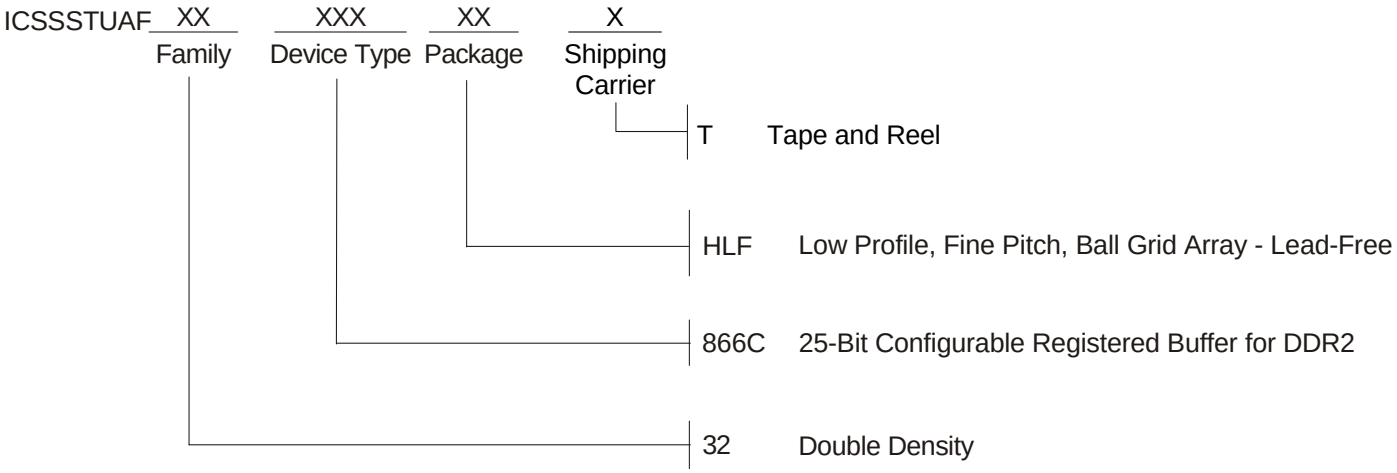
Load Circuit: Partial-Parity-Out Voltage Waveforms Propagation Delay Times (with respect to clock inputs)



Load Circuit: Partial-Parity-Out Voltage Waveforms Propagation Delay Times (with respect to $\overline{\text{RESET}}$ input)

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Ordering Information



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